## Step Down Switching Regulators

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A substantial percentage of regulator requirements involve stepping down the primary voltage. Although linear regulators can do this, they cannot achieve the efficiency of switching based approaches ${ }^{1}$. The theory supporting step down ("buck") switching regulation is well established, and has been exploited for some time. Convenient, easily applied IC's allowing implementation of practical circuits are, however, relatively new. These devices permit broad application of step down regulation with minimal complexity and low cost. Additionally, more complex functions incorporating step down regulation become realizable.

## Basic Step Down Circuit

Figure 1 is a conceptual voltage step down or "buck" circuit. When the switch closes the input voltage appears at the inductor. Current flowing through the inductor-capaci-


Figure 1. Conceptual Voltage Step Down ("Buck") Circuit
tor combination builds over time. When the switch opens current flow ceases and the magnetic field around the inductor collapses. Faraday teaches that the voltage induced by the collapsing magnetic field is opposite to the originally applied voltage. As such, the inductors left side heads negative and is clamped by the diode. The capacitors accumulated charge has no discharge path, and a DC potential appears at the output. This DC potential is lower than the input because the inductor limits current during the switches on-time. Ideally, there are no dissipative elements in this voltage step down conversion. Although the output voltage is lower than the input, there is no energy
lost in this voltage-to-current-to-magnetic field-to-current-to-charge-to-voltage conversion. In practice, the circuit elements have losses, but step down efficiency is still higher than with inherently dissipative (e.g. voltage divider) approaches. Figure 2 feedback controls the basic circuit to regulate output voltage. In this case switch ontime (e.g. inductor charge time) is varied to maintain the output against changes in input or loading.


Figure 2. Conceptual Feedback Controlled Step Down Regulator

## Practical Step Down Switching Regulator

Figure 3, a practical circuit using the $\mathrm{LT} 1074{ }^{2} \mathrm{I} \mathrm{C}$ regulator, shows similarities to the conceptual regulator. Some new elements have also appeared. Components at the LT1074's "VCOMP" pin control the IC's frequency compensation, stabilizing the feedback loop. The feedback resistors are selected to force the "feedback" pin to the devices internal 2.5 V reference value. Figure 4 shows operating waveforms for the regulator at $\mathrm{V}_{\mathbb{N}}=28 \mathrm{~V}$ with a $5 \mathrm{~V}, 1 \mathrm{~A}$ load.

Note 1: While linear regulators cannot compete with switchers, they can achieve significantly better efficiencies than generally supposed. See LTC Application Note 32, "High Efficiency Linear Regulators," for details.

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Figure 3. A Practical Step Down Regulator Using the LT1074


Figure 5. Waveforms for the Step Down Regulator at $\mathrm{V}_{\mathbb{N}}=12 \mathrm{~V}$ and $\mathrm{V}_{\text {OUT }}=5 \mathrm{~V}$ at 1 A

Trace $A$ is the $V_{\text {SW }}$ pin voltage and trace $B$ is its current. Inductor current ${ }^{3}$ appears in trace C and diode current is trace D. Examination of the current waveforms allows determination of the $\mathrm{V}_{\text {SW }}$ and diode path contributions to inductor current. Note that the inductor current's waveform occurs on top of a 1A DC level. Figure 5 shows significant duty cycle changes when $\mathrm{V}_{\mathbb{N}}$ is reduced to 12 V . The lower input voltage requires longer inductor charge times to maintain the output. The LT1074 controls inductor charge characteristics (see Appendix A for operating details), with resulting waveform shape and time proportioning changes.


Figure 4. Waveforms for the Step Down Regulator at $\mathrm{V}_{\mathbb{I}}=28 \mathrm{~V}$ and $\mathrm{V}_{\text {OUT }}=5 \mathrm{~V}$ at 1 A


Figure 6. Efficiency vs AC Line Voltage for the LT1074. LT1086 and LM317 Linear Regulators Are Shown for Comparison.

Figure 6 compares this circuits efficiency with linear regulators in a common and important situation. Efficient regulation under varying $A C$ line conditions is a frequent requirement. The figure assumes the AC line has been transformed down to acceptable input voltages. The input voltages shown correspond to the AC line voltages given on the horizontal axis. Efficiency for the LM317 and LT1086 linear regulators suffers over the wide input range.

[^0]

Figure 7. Efficiency Plot for Figure 3 . Higher Input Voltages Minimize Effects of Saturation Losses, Resulting in Increased Efficiency.

The LT1086 is notably better because its lower dropout voltage cuts dissipation over the range. Switching preregulation ${ }^{4}$ can reduce these losses, but cannot equal the LT1074's performance. The plot shows minimum efficiency of $83 \%$, with some improvement over the full AC line excursion. Figure 7 details performance. Efficiency approaches $90 \%$ as input voltage rises. This is due to minimization of the effects of fixed diode and LT1074 junction losses as input increases. At low inputs these losses are a higher percentage of available supply, degrading efficiency. Higher inputs make the fixed losses a smaller percentage, improving efficiency. Appendix D presents detail on optimizing circuitry for efficiency.

## Dual Output Step Down Regulator

Figure 8, a logical extension of the basic step down converter, provides positive and negative outputs. The circuit is essentially identical to Figure 3's basic converter with the addition of a coupled winding to L1. This floating winding's output is rectified, filtered and regulated to a -5 V output. The floating bias to the LT1086 positive voltage regulator permits negative outputs by assigning the regulator's output terminal to ground. Negative output power is set by flux pick-up from L1's driven winding. With a 2 A load at the +15 output the -5 V output can supply over 500 mA . Because L1's secondary winding is floating its output may be referred to any point within the breakdown capability of the device. Hence, the secondary output could be 5 V or, if stacked on the +15 output, 20 V .

## Negative Output Regulators

Negative outputs can also be obtained with a simple two terminal inductor. Figure 9 demonstrates this by essentially grounding the inductor and steering the catch diodes negative current to the output. A1 facilitates loop closure by providing a scaled inversion of the negative output to the LT1074's feedback pin. The 1\% resistors set the scale factor (e.g. output voltage) and the RC network around A1 gives frequency compensation. Waveforms for this circuit are reminiscent of Figure 5, with the exception

Note 4: See Reference 1.


Figure 8. Coupled Inductor Provides Positive and Negative Outputs


Figure 9. A Negative Output Step Down Regulator
that diode current (trace $D$ ) is negative. Traces $A, B$ and $C$ are $\mathrm{V}_{\text {SW }}$ voltage, inductor current and $\mathrm{V}_{\text {SW }}$ current respectively.
Figure 11, commonly referred to as "Nelson's Circuit," provides the same function as the previous circuit, but eliminates the level-shifting op amp. This design accomplishes the level shift by connecting the LT1074's "ground" pin to the negative output. Feedback is sensed from circuit ground, and the regulator forces its feedback pin 2.5 V above its "ground" pin. Circuit ground is common to input and output, making system use easy. Operating waveforms are essentially identical to Figure 10. Advantages of the previous circuit compared to this one are that the LT1074 package can directly contact a grounded heat sink and that control signals may be directly interfaced to the ground referred pins.
The inductor values in both negative output designs are notably lower than in the positive case. This is necessitated


Figure 10. Figure 9's Waveforms
by the reduced loop phase margin of these circuits. Higher inductance values, while preferable for limiting peak current, will cause loop instability or outright oscillation.

## Current-Boosted Step Down Regulator

Figure 12 shows a way to obtain significantly higher output currents by utilizing efficient energy storage in the LT1074 output inductor. This technique increases the duty cycle over the standard step down regulator allowing more energy to be stored in the inductor. The increased output current is achieved at the expense of higher output voltage ripple.

The operating waveforms for this circuit are shown in Figure 13. The circuit operating characteristics are similar to that of the step down regulator (Figure 3). During the $V_{S W}$ (trace A) "on" time the input voltage is applied to one end of the coupled inductor. Current through the V VW $_{\text {S }}$ pin (trace B) ramps up almost instantaneously (since inductor current (trace F) is present) and then slows as energy is stored in the core. The current proceeds into the inductor (trace D ) and finally is delivered to the load. When the $\mathrm{V}_{S W}$ pin goes off, current is no longer available to charge the inductor. The magnetic field collapses, causing the V VW pin voltage to go negative. At this point similarity with the basic regulator vanishes. In this modified version the output current (trace F) receives a boost as the magnetic field collapses. This results when the energy stored in the core is transferred to the output. This current step circulates


L1=PULSE ENGINEERING, INC. \#PE-S1509
Figure 11. Nelson's Circuit ... A (Better) Negative Output Step Down Regulator


Figure 12. "Current Boosted" Step Down Regulator. Boost Current is Supplied by Energy Stored in the Tapped Inductor.
through C1 and D2 (trace E), somewhat increasing output voltage ripple. Not all the energy is transferred to the "1" winding. Current (trace C ) will continue to flow in the " N " winding due to leakage inductance. A snubber network suppresses the effects of this leakage inductance. For lowest snubber losses the specified tapped inductor is bifilar wound for maximum coupling.

## Post Regulation-Fixed Case

In most instances the LT1074 output will be applied directly to the load. Those cases requiring faster transient response or reduced noise will benefit from linear post regulation. In Figure 14 a three terminal regulator follows the LT1074 output. The LT1074 output is set to provide just


Figure 13. AC Current Flow for the Boosted Regulator enough voltage to the LT1084 to maintain regulation. The LT1084's low dropout characteristics combined with a high circuit input voltage minimizes the overall efficiency penalty.


Figure 14. Linear Post-Regulator Improves Noise and Transient Response

## Post Regulation-Variable Case

Some situations require variable linear post regulation. Figure 15 does this with little efficiency sacrifice. The LT1085 operates in normal fashion, supplying a variable $1.2 \mathrm{~V}-28 \mathrm{~V}$ output. The remainder of the circuit forms a switched mode pre-regulator which maintains a small, fixed voltage across the LT1085 regardless of its output voltage. A1 biases the LT1074 to produce whatever voltage is necessary to maintain the "E diodes" potential across the LT1085. A1's inputs are balanced when the LT1085 output is " $E$ diodes" above its input. A1 maintains this condition regardless of line, load or output voltage conditions. Thus, good efficiency is maintained over the full range of output voltages. The RC network at A1 compensates the loop. Loop start-up is assured by deliberately introducing a positive offset to A1. This is done by grounding A1's appropriate balance pin (5), resulting in a positive 6 mV offset. This increases amplifier drift, and is normally considered poor practice, but causes no measurable error in this application.
As shown, the circuit cannot produce outputs below the LT1085's 1.2 V reference. Applications requiring output adjustability down to $O V$ will benefit from option " $A$ " shown on the schematic. This arrangement replaces L1 with L2. L2's primary performs the same function as L1 and its coupled secondary winding produces a negative bias output ( $-V$ ). The full wave bridge rectification is necessitated by widely varying duty cycles. A2 and its attendant circuitry replace all components associated with the

LT1085 V ${ }_{\text {ADJ }}$ pin. The LT1004 reference terminates the $10 \mathrm{k}-250 \mathrm{k}$ feedback string at -1.2 V with A 2 providing buffered drive to the LT1085 $\mathrm{V}_{\text {ADJ }}$ pin. The negative bias allows regulated LT1085 outputs down to OV. The -V potential derived from L2's secondary varies considerably with operating conditions. The high feedback string values and A2's buffering ensure stable circuit operation for "starved" values of $-V$.

## Low Quiescent Current Regulators

Many applications require very wide ranges of power supply output current. Normal conditions require currents in the ampere range, while standby or "sleep" modes draw only microamperes. A typical lap-top computer may draw 1 to 2 amperes running while needing only a few hundred microamps for memory when turned off. In theory, any regulator designed for loop stability under no-load conditions will work. In practice, a converter's relatively large quiescent current may cause unacceptable battery drain during low output current intervals. Figure 16 's simple loop effectively reduces circuit quiescent current from 6 mA to only $150 \mu \mathrm{~A}$. It does this by utilizing the LT1074's shutdown pin. When this pin is pulled within 350 mV of ground the IC shuts down, pulling only $100 \mu \mathrm{~A}$. Comparator C1 combines with the LT1004 reference and Q1 to form a "bang-bang" control loop around the LT1074. The LT1074's internal feedback amplifier and voltage reference are bypassed by this loops operation. When the circuit output (trace C, Figure 17) falls slightly below 5V C1's output (trace A) switches low, turning off Q1 and enabling the


Figure 15. Adjustable Linear Post-Regulator Maintains Efficiency Over Widely Varying Operating Conditions


Figure 16. A Simple Loop Reduces Quiescent Current to $150 \mu \mathrm{~A}$

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LT1074. The V SW pin (trace B) pulses at full duty cycle, forcing the output back above 5 V . C 1 then biases Q1 again, the LT1074 goes into shutdown, and loop action repeats. The frequency of this on-off control action is directly load dependent, with typical repetition rates of 0.2 Hz at no load. Short on-times keep duty cycle low, resulting in the small effective quiescent current noted. The on-off operation combines with the LC filtering action in the regulator's $V_{S W}$ line to generate an output hysteresis of about 50 mV (again, see Figure 17, trace C).


Figure 17. The Low Quiescent Current Loop's Waveforms

The loop performs well, but has two potential drawbacks. At higher output currents the loop oscillates in the $1 \mathrm{kHz}-10 \mathrm{kHz}$ range, causing audible noise which may be objectionable. This is characteristic of this type of loop, and is the reason that IC's employing gated oscillators invariably produce such noise. Additionally, the control loops operation causes about 50 mV of ripple on the output. Ripple frequency ranges from 0.2 Hz to 10 kHz depending upon input voltage and output current.

Figure 18's more sophisticated circuit eliminates these problems with some increase in complexity. Quiescent current is maintained at $150 \mu \mathrm{~A}$. The technique shown is particularly significant, with broad implication in battery powered systems. It is easily applied to a wide variety of regulator requirements, meeting an acknowledged need across a wide spectrum of applications.

Figure 18 's signal flow is similar to Figure 16, but additional circuitry appears between the feedback divider and the LT1074. The LT1074's internal feedback amplifier and reference are not used. Figure 19 shows operating wave-


Figure 18. A More Sophisticated Loop Gives Better Regulation While Maintaining $150 \mu \mathrm{~A}$ Quiescent Current
forms under no load conditions. The output (trace A) ramps down over a period of seconds. During this time comparator A1's output (trace B) is low, as are the 74C04 paralleled inverters. This pulls the $V_{C}$ pin (trace D) low, forcing the regulator to zero duty cycle. Simultaneously, A2 (trace C) is low, putting the LT1074 in its $100 \mu \mathrm{~A}$ shutdown mode. The $V_{S W}$ pin (trace E) is off, and no inductor current flows. When the output drops about 60 mV , A1 trig. gers and the inverters go high, pulling the $V_{C}$ pin up and biasing the regulator. The zener diode prevents $V_{C}$ pin overdrive. A2 also rises, taking the IC out of shutdown mode. The $\mathrm{V}_{\text {SW }}$ pin pulses the inductor at the 100 kHz clock rate, causing the output to abruptly rise. This action trips A1 low, forcing the $V_{C}$ pin back low and shutting off $V_{S W}$ pulsing. A2 also goes low, putting the LT1074 into shutdown.

This "bang-bang" control loop keeps the 5V output within the 60 mV ramp hysteresis window set by the loop. Note


Figure 19. Low Quiescent Current Regulator's Waveforms With No Load (Traces B, C, and E Retouched for Clarity)


Figure 21. Low Quiescent Current Regulator's Waveforms at 7 mA Loading
that the loop oscillation period of seconds means the R1-C1 time constant at $V_{C}$ is not a significant term. Because the LT1074 spends almost all of the time in shutdown, very little quiescent current ( $150 \mu \mathrm{~A}$ ) is drawn.
Figure 20 shows the same waveforms with the load increased to 2 mA . Loop oscillation frequency increases to keep up with the loads sink current demand. Now, the $V_{C}$ pin waveform (trace D) begins to take on a filtered appearance. This is due to R1-C1's 10 ms time constant. If the load continues to increase, loop oscillation frequency will also increase. The R1-C1 time constant, however, is fixed. Beyond some frequency, R1-C1 must average loop oscillations to DC. At 7 mA loading (Figure 21) loop frequency further increases, and the $V_{C}$ waveform (trace $D$ ) appears heavily filtered.
Figure 22 shows the same circuit points at 2 A loading. Note that the $V_{C}$ pin is at $D C$, as is the shutdown pin. Repetition rate has increased to the LT1074's 100 kHz clock


Figure 20. Low Quiescent Current Regulator's Waveforms at 2 mA Loading


Figure 22. Low Quiescent Current Regulator's Waveforms at 2A Loading

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frequency. Figure 23 plots what is occurring, with a pleasant surprise. As output current rises, loop oscillation frequency also rises until about 23 Hz . At this point the R1-C1 time constant filters the $V_{C}$ pin to DC and the LT1074 transitions into "normal" PWM operation. With the $V_{C}$ pin at DC it is convenient to think of A1 and the inverters as a linear error amplifier with a closed loop gain set by the R2-R3 feedback divider. In fact, A1 is still duty cycle modulating, but at a rate far above R1-C1's break frequency. The phase error contributed by C2 (which was selected for low loop frequency at low output currents) is dominated by the R1-C1 roll off and the C3 lead into A1. The loop is stable and responds linearly for all loads beyond 10 mA . In this high current region the LT1074 is desirably "fooled" into behaving like a conventional step down regulator.

A formal stability analysis for this circuit is quite complex, but some simplifications lend insight into loop operation. At $250 \mu \mathrm{~A}$ loading ( $20 \mathrm{k} \Omega$ ) C2 and the load form a decay time constant exceeding 30 seconds. This is orders of magnitude larger than R2-C3, R1-C1, or the LT1074's 100 kHz commutation rate. As a result, C2 dominates the loop. Wideband A1 sees phase shifted feedback, and very low frequency oscillations similar to Figure 19's occur ${ }^{5}$. Although C2's decay time constant is long, its charge time constant is short because the circuit has low sourcing impedance. This accounts for the ramp nature of the oscillations.

Increased loading reduces the C2-load decay time constant. Figure 23 's plot reflects this. As loading increases,


Figure 23. Figure 18's Loop Frequency vs Output Current. Note Linear Loop Operation Above 10 mA .
the loop oscillates at a higher frequency due to C2's decreased decay time. When the load impedance becomes low enough C2's decay time constant ceases to dominate the loop. This point is almost entirely determined by R1 and C1. Once R1 and C1 "take over" as the dominant time constant the loop begins to behave like a linear system. In this region (e.g. above about 10mA, per Figure 23) the LT1074 runs continuously at its 100 kHz rate. Now, C3 becomes significant, performing as a simple feedback lead ${ }^{6}$ to smooth output response. There is a fundamental trade-off in the selection of the C3 lead value. When the converter is running in its linear region it must dominate the loops time lag generated hysteretic characteristic. As such, it has been chosen for the best compromise between output ripple at high load and loop transient response.

Despite the complex dynamics transient response is quite good. Figure 24 shows performance for a step from no load to 1A. When trace A goes high a 1A load appears across the output (trace C). Initially, the output sags almost 200 mV due to slow loop response time (the R1-C1 pair delay $V_{C}$ pin (trace B) response). When the LT1074 comes on response is reasonably quick and surprisingly well behaved considering circuit dynamics. The multi-time constant recovery ${ }^{7}$ ("rattling" is perhaps more appropriate) is visible in trace C's response.

Note 5: Some layouts may require substantial trace area to A1's inputs. In such cases the optional RC network around A1 ensures clean transitions at A1's output.
Note 6: "Zero Compensation" for all you technosnobs out there.
Note 7: Once again, "multi-pole settling" for those who adore jargon.


Figure 24. Load Transient Response for Figure 18

Figure 25 plots efficiency vs. output current. High power efficiency is similar to standard converters. Low power efficiency is somewhat better, although poor in the lowest ranges. This is not particularly bothersome, as power loss is very small.

The loop provides a controlled, conditional instability instead of the usually more desirable (and often elusive) unconditional stability. This deliberately introduced characteristic dramatically lowers converter quiescent current without sacrificing high power performance.


Figure 25. Efficiency vs Output Current for Figure 18 . Standby Efficiency is Poor, But Power Loss Approaches Battery Self. Discharge

## Wide Range, High Power, High Voltage Regulator

BEFORE PROCEEDING ANY FURTHER, THE READER IS WARNED THAT CAUTION MUST BE USED IN THE CONSTRUCTION, TESTING AND USE OF THIS CIRCUIT. HIGH VOLTAGE, LETHAL POTENTIALS ARE PRESENT IN THIS CIRCUIT. EXTREME CAUTION MUST BE USED IN WORKING WITH AND MAKING CONNECTIONS TO THIS CIRCUIT. REPEAT: THIS CIRCUIT CONTAINS DANGEROUS, HIGH VOLTAGE POTENTIALS. USE CAUTION.
Figure 26 is an example of the LT1074 making a complex function practical. This regulator provides outputs from millivolts to 500 V at 100 W with $80 \%$ efficiency. A1 compares a variable reference voltage with a resistively scaled version of the circuits output and biases the LT1074 switching regulator configuration. The switcher's $D C$ output drives a toroidal DC - $D C$ converter comprised of $\mathrm{Li}, \mathrm{Q} 1$
and Q2. Q1 and Q2 receive out of phase square wave drive from the $74 \mathrm{C74} \div 4$ flip.flop stage and the LT1010 buffers. The flip-flop is clocked from the LT1074 $\mathrm{V}_{\text {SW }}$ output via the Q3 level shifter. The LT1086 provides 12 V power for A1 and the 74C74. A1 biases the LT1074 regulator to produce the DC input at the DC-DC converter required to balance to 1000 . The converter has a voltage gain of about 20 , resulting in high voltage output. This output is resistively divided down, closing the loop at A1's negative input. Frequency compensation for this loop must accommodate the significant phase errors generated by the LT1074 configuration, the DC-DC converter and the output LC filter. The $0.47 \mu \mathrm{~F}$ roll-off term at A1 and the $100 \Omega-0.15 \mu \mathrm{~F}$ R lead network provide the compensation, which is stable for all loads.
Figure 27 gives circuit waveforms at 500 V output into a 100W load. Trace $A$ is the LT1074 $\mathrm{V}_{\text {SW }}$ pin while trace $B$ is its current. Traces C and D are Q1 and Q2's drain waveforms. The disturbance at the leading edges is due to cross-current conduction, which lasts about 300ns - a small percentage of the cycle. Transistor currents during this interval remain within reasonable values, and no overstress or dissipation problems occur. This effect could be eliminated with non-overlapping drive to Q1 and Q2 ${ }^{8}$, although there would be no reliability or significant efficiency gain. The 500 kHz ringing on the same waveforms is due to excitation of transformer resonances. These phenomena are not deleterious, although LI's primary RC damper is included to minimize them.
All waveforms are synchronous because the flip-flop drive stage is clocked from the LT1074 $\mathrm{V}_{\text {SW }}$ output. The LT1074's maximum $95 \%$ duty cycle means that the Q1.Q2 switches can never see destructive DC drive. The only condition allowing DC drive occurs when the LT1074 is at zero duty cycle. This case is clearly non-destructive, because L1 receives no power.

Figure 28 shows the same circuit points as Figure 27, but at only 5 mV output. Here, the loop restricts drive to the DC-DC converter to small levels. Q1 and Q2 chop just 70 mV into L1. At this level L1's output diode drops look large, but loop action forces the desired 0.005 V output.

[^1]

Figure 27. Figure 26's Operating Waveforms at 500 V Output Into a 100W Load


Figure 29. Figure 26's Output Noise at 500V into a 100 W Load. Residue is Composed of Q1-Q2 Chopping Artifacts and Transformer Related Ringing. DANGER! Lethal Potentials Present-See Text.

The LT1074's switched mode drive to L1 maintains high efficiency at high power, despite the circuits wide output range?

Figure 29 shows output noise at 500 V into a 100 W load. Q1-Q2 chopping artifacts and transformer related ringing are clearly visible, although limited to about 80 mV . The coherent noise characteristic is traceable to the synchronous clocking of Q1 and Q2 by the LT1074.

A 50 V to 500 V step command into a 100 W load produces the response of Figure 30. Loop response on both edges is


Figure 28. Figure 26 's Operating Waveforms at 0.005 V Output

Figure 30. 500V Step Response with 100W Load (Photo Retouched for Clarity). DANGER! Lethal Potentials Present - See Text.
clean, with the falling edge slightly underdamped. This slew asymmetry is typical of switching configurations, because the load and output capacitor determine negative slew rate. The wide range of possible loads mandates a compromise when setting frequency compensation. The falling edge could be made critically or even over damped, but response time for other conditions would suffer. The compensation used seems a reasonable compromise.

Note 9: A circuit related to the one presented here appears in LTC Application Note 6. Its linear drive to the step-up DC-DC converter forces dissipation, limiting output power to about 10 W .

## Regulated Sinewave Output DC.AC Converter

BEFORE PROCEEDING ANY FURTHER, THE READER IS WARNED THAT CAUTION MUST BE USED IN THE CON. STRUCTION, TESTING AND USE OF THIS CIRCUIT. HIGH VOLTAGE, LETHAL POTENTIALS ARE PRESENT IN THIS CIRCUIT. EXTREME CAUTION MUST BE USED IN WORKING WITH AND MAKING CONNECTIONS TO THIS CIRCUIT. REPEAT: THIS CIRCUIT CONTAINS DANGEROUS, HIGH VOLTAGE POTENTIALS. USE CAUTION.
Figure 31 is another example of the LT1074 permitting the practical implementation of a complex function. It converts a 28 V DC input to a regulated $115 \mathrm{~V}_{\mathrm{AC}} 40 \mathrm{~Hz}$ sinewave output with $80 \%$ efficiency. Waveform distortion is below $1.6 \%$ at 50 W output. This design shares similarities with the previous circuit. The LT1074 supplies efficient drive to a high voltage converter despite large line and load variations. An amplifier (A1) controls the input to the high voltage converter via A2 and the LT1074 switching regulator. The high voltage output is divided down and fed back to the amplifier where it is compared to a reference to close a loop. In the previous circuit the output is DC ; here the output is AC. As such, A1's reference (trace A, Figure 32 ) is an amplitude and frequency stabilized 800 Hz hal-sine ${ }^{10}$. The high voltage converter is driven from a flipflop clocked by a reference synchronized pulse (negative going excursions just visible in trace B) via level shift transistor Q3. The reference synchronized pulse occurs at the zero voltage point of the half-sine. The flip-flop outputs (traces C and D, respectively) drive the Q1 and Q2 gates. RC filters in the gate line retard the drive's slew rate.
A1 biases the LT1074's $V_{C}$ pin via A2 to produce an 800 Hz half-sine signal at L2's center tap (trace E). Because Q1 and Q2 are synchronously driven with the reference halfsine their drain waveforms (traces F and G) reveal alternate chopping of complete half cycles. L2 receives balanced drive and its secondary recombines the chopped half-sines into a $115 V_{A C} 400 \mathrm{~Hz}$ sinewave output (trace H ). The diode bridge rectifies L2's output back to an 800 Hz half-sine which is fed to A1 via the resistor divider. A1 balances this signal against the reference hall-sine to close a loop. Transmitting the 800 Hz waveform around the loop requires attention to available bandwidth. The LT1074's 100 kHz switching frequency is theoretically high enough to permit this, but the bandwidth attenuation of its output

LC filter must be considered. The unusually low output filter capacitor value allows the necessary frequency response. A1's $330 \mathrm{k}-0.01 \mu \mathrm{~F}$ components combine with the RC lead network across the 16 k feedback resistor to stabilize the loop.

A2 closes a local loop around the LT1074 configuration. This is necessary because L2 blocks DC information from being conducted around A1's loop. This is a concern because the waveform presented to L2's primary center tap must have no DC component. DC content at this point will cause waveform distortion, transformer power dissipation or both. The LT1074's $V_{C}$ pin operates with substantial and uncertain DC bias, making A1's inability to control DC errors unacceptable. A2 corrects this by biasing the LT1074 $V_{C}$ pin at its $D C$ threshold so that no $D C$ component is presented to L2. A1's output represents the difference between the $A C$ coupled circuit output and the half-sine reference. A2's output contains this information in addition to DC restoration information. L2 and A1 contribute essentially no DC error, so A2's loop may be closed at the LT1074 configuration's output. A2's feedback capacitor stabilizes this local loop.
The drive to $L 2$ cannot sink current. This means that any residual energy stored in $L 2$ when the drive waveform goes to zero sees no exit path. This is a relatively small effect, but can cause output crossover distortion. The synchronous switch option shown on the schematic provides such a path, and is recommended for lowest output distortion. This optional circuitry is detailed in Appendix E.
Figure 33A and 33B show waveforms in the "turnaround" region of circuit operation. This is the most critical part of the converter, and its characteristics directly determine output waveform purity. Figure 33 A (trace A), a highly amplitude and time expanded version of L2's center tap drive, arrives at 0 V (upper cross-etched horizontal line) and turns around cleanly. This action is just slightly time skewed from the reference synchronized pulse (trace B). The aberration on the rising edge is due to the optional synchronous switch's operation. This switch is shorted during the on-time of trace C's pulse (see Appendix E for operating details of this option). Trace D, Q2's gate drive,

Note 10: Complete operating details of the half-sine reference generator appear in Appendix E.



Figure 31. LT1074 Based $+28-110 \mathrm{VAC} 400 \mathrm{~Hz}$ Converter. Sinewave Output Shows Only $1.6 \%$ Distortion. DANGERI Lethal Potentials Present - See Text.
aligns with trace B's pulse. The slew reduction caused by the $1 \mathrm{k}-0.01 \mu \mathrm{~F}$ filter is clearly visible, and contributes to trace A's low noise turnaround. The LT1074's 100kHz chopping related components are easily observed in trace $A$. Waveforms at the next half cycle's zero point (e.g. Q1's gate driven) are identical.


Figure 32. $+28-110 \mathrm{VAC}, 400 \mathrm{~Hz}$ Converter's Waveforms. The Optional Synchronous Switch is Disabled in this Photo, Resulting in Relatively High Crossover Distortion (Trace H). DANGER! Lethal Potentials Present - See Text.

$H O R I Z=50 \mu S / D I V$


HORIZ $=50 \mu \mathrm{~S} / \mathrm{DIV}$
Figure 33B
Figure 33A and 33B. Details of "Turnaround" Sequence. Switching Characteristics Directly Determine Output Crossover Distortion. DANGER! Lethal Potentials Present - See Text.

Figure 33B shows additional details at highly expanded amplitude and time scales. L2's center tap is trace A, Q1's drain is trace $B$ and $Q 2$ 's drain trace $C$. The output sinewave (trace $D$ ) is shown as it crosses through zero.


Figure 34. Distortion and Spectral Characteristics for the Sinewave Output Converter. Distortion Trace (B) Shows Crossover Abberations and LT1074 Wideband Chopping Residue. The Synchronous Switch Option is Employed in This Photo for Lowest Distortion. DANGER! Lethal Potentials Present - See Text.

Figure 34 studies waveform purity. Trace $A$ is the sinewave output at 50W loading. Trace B shows distortion products, which are dominated by turnaround related crossover aberrations and LT1074 100 kHz chopping residue. Although not strictly necessary, the LT1074's switching can be synchronized to the reference half-sine for coherent noise characteristics. This option is discussed in Appendix E , along with other reference generator details. Trace C is a spectrum analysis centered at 400 Hz . In this photo the optional synchronous switch is used, accounting for improved crossover characteristics over Figure 32.
If a fully floating output is desired the output diode bridge can be isolated by a simple $1: 1$ ratio transformer. To calibrate this circuit trim the "output adjust" potentiometer for a $115 V_{\text {AC }}$ output. Regulation remains within $1 \%$ over wide variations of input and load.

Note 11: Test equipment aficionados may wish to consider how this picture was taken. Hint: Double exposure techniques were not used. This photograph is a real time, simultaneous display of frequency and time domain information.

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## APPENDIX A

## Physiology of the LT1074

The LT1074 uses standard (as opposed to current mode) pulse width modulation, with two important differences. First, it is a clocked system with a maximum duty cycle of approximately $95 \%$. This allows a controlled start-up when it is used as a positive to negative converter or a negative boost converter. Second, duty cycle is an inverse function of input voltage ( $D C \approx 1 / V_{\mid N}$ ), without any change in error amplifier output. This greatly improves line transient response and ripple rejection, especially for designs which have the control loop over-damped.

Referring to the block diagram, the heart of the LT1074 consists of the oscillator, the error amplifier A1, an analog multiplier, comparator C6, and an RS flip-flop. A complete switching cycle begins with the reset (down ramp) period of the oscillator. During this time ( $\approx 0.7 \mu \mathrm{~s}$ ), the RS flip-flop is set and the switch driver Q104 is kept off via the "and " gate G1. At the end of the reset time, Q104 turns on and drives the output switch Q111, Q112, and Q113. The oscillator ramp starts upward, and when it is equal to the output voltage of the analog multiplier, C6 resets the RS flip-flop, turning off the output switch. Duty cycle is therefore controlled by the output of the multiplier which in turn is controlled by the output of the error amplifier, A1.

A multiplier is used in the LT1074 to provide a perfect "feed forward" function. Conventional switching regulators sometimes use a simple form of feed forward to adjust duty cycle immediately when input voltage changes. This reduces the requirement for voltage swing at the output of the error amplifier as it tries to correct for line variations. Bandwidth of switching regulator error amplifiers must be fairly low to maintain loop stability, so rather large output perturbations occur when the output of the error amplifier must move quickly to correct for line variations. Conventional feed forward schemes typically operate well over a restricted input voltage range or are effective only at certain frequencies. The multiplier technique is very effective over the full range of input voltage and at all frequencies. The basic function is to compensate for the generalized buck regulator transfer function; $\mathrm{V}_{\text {OUT }}=(\mathrm{V} \mid \mathbb{N})$ (DC), where $D C=$ switch duty cycle. This transfer function has two implications. First, it is obvious that to maintain a constant output, duty cycle must change inversely with input voltage. Second, input voltage appears in the loop transfer function, i.e., a fixed variation in duty cycle gives different variations in output voltage depending on input voltage. Loop gain is directly proportional to input voltage, and this can cause loop instability or slow loop response
if input voltage varies over a wide range. The multiplier takes out all input voltage effects by automatically adjusting loop gain inversely with input voltage. The multiplier output $\left(V_{0}\right)$ is equal to error amplifier output $\left(V_{E}\right)$ divided by input voltage $\left(V_{\mid N}\right) ; V_{0}=\left(V_{R}\right) \cdot\left(V_{E}\right) /\left(V_{I N}\right) . V_{R}$ is a fixed voltage required by all analog multipliers to define multiplier gain. It has an effective value of approximately 20 V in the LT1074.

The error amplifier used in the LT1074 is a transconductance type. It has high output impedance ( $\approx 500 \mathrm{k} \Omega$ ), so that its $A C$ voltage gain is defined by the impedance of external shunt frequency compensation components $\left(\mathrm{Z}_{\mathrm{C}}\right)$ and the transconductance (gm) of the amplifier, $\mathrm{A}_{\mathrm{V}}=(\mathrm{gm})$ ( $\mathrm{A}_{\mathrm{C}}$ ). gm is $\approx 3500 \mu \mathrm{mho}$. The error amplifier has its non-inverting input committed to an internal 2.3 V reference. The inverting input (fb) is brought out for connection to an external voltage divider that establishes regulator output voltage.

Two other connections are made internally to the fb pin. A window comparator consisting of C4, C5, and some logic provides an "output status" function. It monitors the voltage on the fb pin and gives a "high" output only when the fb voltage is within $\pm 5 \%$ of the internal reference voltage. This status output can be used to alert external circuitry that the regulator output is "in" or "out" of regulation. The delay and one shot circuits ensure that switching EMI will not cause spurious outputs, and that the minimum time for an "out-of-bounds" (low) status output is $\cong 20 \mu \mathrm{~s}$. Also tied to the fb pin is a frequency shift circuit consisting of R15 and Q36. The base of Q36 is biased at $\cong 1 \mathrm{~V}$ so that Q36 turns on when the fb pin drops below $\approx 0.6 \mathrm{~V}$. Current through Q36 smoothly decreases oscillator frequency. This is necessary for maintaining control of current limit at high input voltages. A "dead short" on the output of a switching regulator requires that switch "on" time reduce to $\left(V_{D}\right) /\left(V_{\mathbb{N}}\right)(f)$, where $V_{D}$ is the forward voltage of the output catch diode and $f$ is switching frequency. $V_{D}$ is typically 0.5 V for a Schottky catch diode, forcing switch "on" time to shrink to a theoretical $0.1 \mu \mathrm{~s}$ for a 50 V input and 100 kHz switching frequency with a shorted output. In practical circuits, effective "on" time can stretch to $0.3 \mu \mathrm{~S}$ under these conditions due to losses in the inductor wire resistance and switch rise and fall time. The LT1074 can-
not reduce switch "on" time to less than $\cong 0.6 \mu$ s in current limit because it has true pulse-by-pulse switch current limiting. The current limit circuitry must sense switch current after the switch turns on, and then send a signal to turn the switch off. Minimum time for this signal path is $0.6 \mu \mathrm{~s}$. Full control of current limit is maintained by reducing switching frequency when the output falls to less than approximately $15 \%$ of its regulated value. This has no affect on normal operation and does not change the selection of external components such as the inductor or output capacitor.

True pulse-by-pulse current limiting is performed by comparator $\mathrm{C7}$. It monitors the voltage across sense resistor R52 and resets the RS flip-flop. Current limit threshold is set by the voltage across R47 which in turn is set by the voltage on the lLIM pin. The llIM voltage is determined by an external resistor or by an internal clamp of 5 V if no external resistor is used. To compensate for the temperature coefficient of R47 ( $\approx+0.25 \% /{ }^{\circ} \mathrm{C}$ ), the internal current source IL has a matching positive temperature coefficient. Its nominal value is $300 \mu \mathrm{~A}$ at $25^{\circ} \mathrm{C}$. Current limit can be set from 1A to 6 A with one external resistor between lum and ground. If no resistor is used, the lum pin will self clamp at $\cong 5 \mathrm{~V}$ and current limit will be $\approx 6.5 \mathrm{~A}$. A small pre-bias is added to the negative input of C 7 to ensure that current limit will go to zero (no switching) when the lum pin is pulled to OV, either by an external short or via Q11 during under-voltage lockout. Soft start can be achieved by connecting a capacitor to the lum pin. Fold-back current limiting can also be implemented by connecting a resistor from luim to the regulated output.

Switching frequency of the LT1074 is internally set at 100 kHz , but can be increased by connecting a resistor from the frequency pin to ground. This resistor biases on Q79 and feeds extra current into the oscillator. Maximum suggested frequency is 200 kHz . A comparator, C 3 , is also connected to the frequency pin and allows this pin to be used for synchronizing the oscillator to an external clock, even when the pin is also being used to boost oscillator frequency. R35 keeps the frequency pin biased correctly in a no-function state when it is left open and R36 limits Q79 current if the frequency pin is accidentally shorted to ground.


Figure A1. Simplified LT1074 Internal Details

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The shutdown pin on the LT1074 can be used as a logic control of output switching, as an under-voltage lockout, or to put the regulator into complete shutdown with ISUPPLY $\approx 100 \mu \mathrm{~A}$. Comparator C 2 has a threshold of 2.5 V . It forces the output switch to a 100\% "off" condition by pulling the ILIM pin low via Q11. Under-voltage lockout is implemented through C 2 by connecting the tap of an input voltage divider to the shutdown pin. Full micropower shutdown of the regulator is achieved by pulling the shutdown pin below the 0.30 V threshold of C 1 . This turns off the chip by shutting down the internal 6 V bias supply. An internal $10 \mu \mathrm{~A}$ current source pulls the shutdown pin high (inactive) if it is left open.

The Comout pin is an open-collector NPN whose collector voltage is the complement of the switch output (VSW). Q87 is specified to drive up to 10 mA and 30 V . It is intended to drive the gate of an external $N$-channel MOS switch which is in parallel with the catch diode. The MOS switch then acts as a synchronous rectifier, which can significantly improve converter efficiency in low output voltage applications. The Comout pin can also be used to drive the gate of
an external P-channel MOS switch in parallel with the internal bipolar switch to provide ultra-high efficiency switching at lower input voltages. A slight time-shift in the Comout signal prevents switch overlap problems.

The combination of these features produces a DC-to-DC converter with the electrical characteristics shown in Figure A2.

| PARAMETER | CONDITIONS | UNITS |
| :--- | :--- | :--- |
| Input Voltage Range |  | 4.5 V to 60 V |
| Output Voltage Range |  | 2.5 V to 50 V |
| Output Current Range | Standard Buck <br> Tapped Buck | 0 A to 5 A |
|  |  | 0 A to 10 A |
| Quiescent Input Current |  | 7 mA |
| Switching Frequency |  | 100 kHz to 200kHz |
| Switch Rise/Fall Times |  | 50 ns |
| Switch Voltage Loss | 1 A | 1.6 V |
|  | 5 A | 2 V |
| Reference Voltage |  | $2.35 \mathrm{~V} \pm 1.5 \%$ |
| Line/Load Regulation |  | $0.05 \%$ |
| Efficiency | Vout $=15 \mathrm{~V}$ | $90 \%$ |
|  | VOuT $^{2}=5 \mathrm{~V}$ | $80 \%$ |

Figure A2. LT1074 Electrical Characteristics

## APPENDIX B

## GENERAL CONSIDERATIONS FOR SWITCHING REGULATOR DESIGN

## Inductor Selection

Magnetic considerations are easily the most common problem area in switching regulator design. Ninety percent of the difficulties encountered are traceable to the inductive components in the circuit. The overwhelming level of difficulty associated with magnetics mandates a judicious selection process. The most common difficulty is saturation. An inductor is saturated when it cannot hold any more magnetic flux. As an inductor arrives at saturation it begins to look more resistive and less inductive. Under these conditions current flow is limited only by the inductor's DC copper resistance and the source capacity. This is why saturation often results in destructive failures.

While saturation is a prime concern, cost, heating, size, availability and desired performance are also significant. Electromagnetic theory, although applicable to these issues, can be confusing, particularly to the non-specialist.

Practically speaking, an empirical approach is often a good way to address inductor selection. It permits realtime analysis under actual circuit operating conditions using the ultimate simulator - a breadboard. If desired, inductor design theory can be used to augment or confirm experimental results.

Figure B1 shows a typical step down converter utilizing the LT1074 switching regulator. A simple approach may be employed to determine the appropriate inductor. A very useful tool is the \#845 inductor kit ${ }^{12}$ shown in Figure B2. This kit provides a broad range of inductors for evaluation in test circuits such as Figure B1.

[^2]Figure B 3 was taken with a $450 \mu \mathrm{H}$ value, high core capacity inductor installed. Circuit operating conditions such as input voltage and loading are set at levels appropriate to the intended application. Trace A is the LT1074's $V_{S W}$ pin voltage while trace $B$ shows its current. When $V_{S W}$ pin voltage is high, inductor current flows. The high inductance means current rises relatively slowly, resulting in the shallow slope observed. Behavior is linear, indicating no saturation problems. In Figure B4, a lower value unit with equivalent core characteristics is tried. Current rise is steeper, but saturation is not encountered. Figure B5's selected inductance is still lower, although core characteristics are similar. Here, the current ramp is quite pronounced, but well controlled. Figure B 6 brings some informative surprises. This high value unit, wound on a low capacity core, starts out well but heads rapidly into saturation, and is clearly unsuitable.
The described procedure narrows the inductor choice within a range of devices. Several were seen to produce


Figure B1. Basic LT1074 Test Circuit


Figure B2. Model 845 Inductor Selection Kit from Pulse Engineering, Inc. Includes 18 Fully Specified Devices
acceptable electrical results, and the "best" unit can be further selected on the basis of cost, size, heating and other parameters. A standard device in the kit may suffice, or a derived version can be supplied by the manufacturer.

Using the standard products in the kit minimizes specification uncertainties, accelerating the dialogue between user and inductor vendor.


Figure B3. Waveforms for $450 \mu \mathrm{H}$, High Capacity Core Unit


Figure B4. Waveforms for $170 \mu \mathrm{H}$, High Capacity Core Unit


Figure B5. Waveforms for $55 \mu \mathrm{H}$, High Capacity Core Unit

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## Inductor Selection - Alternate Method

There are alternate inductor selection methods to the one described. One of the most popular is utilized by those devoid of the recommended inductor kit, time or adequate instrumentation. What is usually desired is to get a prototype LT1074 circuit running NOW. What is often available is limited to a drawer of inductors (see Figure B7) of unknown or questionable lineage. Selection of an appropriate inductor is (hopefully) made by simply inserting one of these drawer dwellers into an unsuspecting LT1074 circuit. Although this methods theoretical premise is perhaps questionable, its seemingly limitless popularity compels us to address it. We have developed a two step procedure for screening inductors of unknown characteristics. Inductors passing both stages of the test have an excellent chance ( $75 \%$ - based on our sample of randomly selected


Figure B6. Waveforms for $500 \mu \mathrm{H}$, Low Capacity Core Inductor (Note Saturation Effects)


Figure B8. Typical Inductor Test Facility
inductors) of performing adequately in a prototype LT1074 circuit. The only instrumentation required is an ohmmeter and a scale.

Test 1 consists of weighing the candidate inductor.Acceptable limits range between 0.01 and 0.25 pounds. This test is best performed at an Inductor Test Facility (see Figure B8), where precision scales are readily available. To save time the quick checkout line is recommended (but only if you have nine ${ }^{13}$ inductors or less - no cheating).

Figure B9 shows an inductor under test. The 0.13 pound weight indicated by the scale places this unit well within acceptable limits.

Note 13: The maximum permitted number of items in the quick checkout line varies from facility to facility. Please be familiar with and respect local regulations.


Figure B7. "Yeah, We Got Some Inductors in a Drawer. I'm Sure They'Il Work ..."


Figure B9. Inductor Under Test (Don't Forget to Pick-Up a Loaf of Bread and a Dozen Eggs)

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The second test involves measuring the inductors DC resistance. Acceptable limits are usually between 0.010 and 0.252 . Inductors passing both tests will probably function in a prototype LT1074 circuit. Figures B10 and B11 show typical acceptable and unacceptable inductors. Graduates tend to be relatively dense, with (where visible) thick wire. Flunkers are usually less dense, with small (again, where visible) wire sizes.
When using an inductor selected with this method try low power first, then gradually increase loading. Observe inductor and LT1074 heating, making sure their dissipation is reasonable (warm to the touch). Disproportionate increases in heating as load is increased probably indicate inductor saturation. Either reduce the load, or go back to the drawer and try again.


Figure B10. Typical Acceptable Inductors


Figure B11. Typical Unacceptable Inductors

While these two tests are somewhat lacking in rigor they do increase the chances of quickly getting a circuit to run with available components. In the longer term, the appropriate inductor can be decided upon and specified.

For the theoretically minded, test 1 grades out inductors which are unlikely to have enough flux storage capability (core mass) to avoid saturation. Test 2 eliminates units with too high a resistance to efficiently support typical LT1074 operating currents. Expanded discussion and design considerations for inductors will be found in Reference 4.

## Capacitors

Think about requirements in capacitors. All operating conditions should be accounted for. Voltage rating is the most obvious consideration, but remember to plan for the effects of equivalent series resistance (ESR) and inductance. These specifications can have significant impact on circuit performance. In particular, an output capacitor with high ESR can make ioop compensation difficult or decrease efficiency.

## Layout

Layout is vital. Don't mix signal, frequency compensation, and feedback returns with high current returns. Arrange the grounding scheme for the best compromise between AC and DC performance. In many cases, a ground plane may help. Account for possible effects of stray inductorgenerated flux on other components and plan layout accordingly.

## Diodes

Diode breakdown and switching ratings must be thought through. Account for all conditions. Transient events usually cause the most trouble, introducing stresses that are often hard to predict. Study the datasheet breakdown, current capacity, and switching speed ratings carefully. Were these specifications written under the same conditions that your circuit is using the device in? If in doubt, consult the manufacturer.

Switching diodes have two important transient characteristics - reverse recovery time and forward turn-on time.

Reverse recovery time occurs because the diode stores charge during its forward conducting cycle. This stored charge causes the diode to act as a low impedance conductive element for a short period of time after reverse drive is applied. Reverse recovery time is measured by forward biasing the diode with a specified current, then forcing a second specified current backwards through the diode. The time required for the diode to change from a reverse conducting state to its normal reverse non-conducting state is reverse recovery time. Hard turn-off diodes switch abruptly from one state to the other following reverse recovery time. They therefore dissipate very little power even with moderate reverse recovery times. Soft turn-off diodes have a gradual turn-off characteristic that can cause considerable diode dissipation during the turnoff interval.

Fast diodes can be useless if stray inductance is high in the diode, output capacitor or LT1074 loop. 20-gauge hook-up wire has $30 \mathrm{nH} /$ inch inductance. Switching currents on the order of $10^{8} \mathrm{~A} / \mathrm{sec}$ are typical in regulator circuits. They can easily generate volts per inch in wiring.

Keep the diode, capacitor and LT1074 input/switch lead lengths SHORT!

## Frequency Compensation

The basic LT1074 step down configuration is relatively free of frequency compensation difficulties. The simple RC damper networks shown from the $V_{C}$ pin to ground will usually suffice. Things become more complex when gain and phase contributing elements are added to the basic loop. In these cases it is often useful to look at the LT1074 as a low bandwidth power stage. The delays are due to the sampled data nature of power delivery ( 100 kHz switching frequency) and the output LC filter. In general, complex loops can be stabilized by limiting the gain-bandwidth of the LT1074 below that of the added elements. This is in accordance with well known feedback theory. A discussion of practical techniques for stabilizing such loops, "The Oscillation Problem (Frequency Compensation Without Tears)," appears at the end of LTC Application Note 18. Other pertinent comments appear in the "Frequency Compensation" sections of LTC Application Notes 19 and 25.

## APPENDIXC

## Techniques and Equipment for Current Measurement

Accurate measurement of current flow under rapidly changing circuit conditions is essential to switching regulator design. In many cases current waveforms contain more valuable information than voltage measurements. The most powerful and convenient current measuring tool is the clip-on current probe. Several types appear in Figure C1. The Tektronix P-6042, shown bottom left, is a Hall effect stabilized current transformer which responds from DC to 50 MHz . The more recent Tektronix AM-503 (not shown) has similar specifications. The combination of convenience, broad bandwidth and DC response make Hall effect stabilized current probes the instrument of choice for converter design. The DC response allows determination of DC content in high speed current waveforms. The clip-on probe contains a current transformer and a Hall effect device. The Hall device senses at DC and low frequency while the transformer simultaneously processes high frequency content. Careful roll-off
matching allows a composite output with no peaking or response aberrations at the two sensors bandwidth crossover. Sensitivity ranges from fractions of a milliampere to amperes and is switch selectable.

Transformer based clip-on current probes are also available. These types lack the DC response of their Hall effect augmented cousins, but are still quite useful. The Tektronix type 131 (and the more modern 134) responds from hundreds of hertz to about 40MHz. AC current probes (type 131 appears in C1, upper left) are as convenient to use as Hall types, but cannot respond at low frequency. AC current probes are also available with a simple termination (left foreground, Figure C1). These types are more difficult to use than the actively terminated models (e.g. type 131 shown) because of complex gain switching. Their low frequency limitations are also poorer, although their high frequency response exceeds 100 MHz .

A final form of AC current probe is the simple transformer shown in Figure C1's foreground. These are not clip-on devices, and usually have significant performance limitations compared to the instruments discussed. However, they are inexpensive and can provide meaningful measurement results when used according to manufacturers recommendations. In use, the conductor is threaded through the opening provided and the signal monitored at the output pins.
Figure C 1 also shows a wide-ranging DC clip-on current probe. The Hewlett-Packard 428B (upper right) responds from DC to only 400 Hz , but features $3 \%$ accuracy over a $100 \mu \mathrm{~A}$ to 10 A range. This instrument obviously cannot discern high speed events, but is invaluable for determining overall efficiency and quiescent current.


Figure C1. Various Current Probe Types Provide Different Capabilities. Selection Criteria is Application Dependent.

A great strength of the probes described is that they take a fully floating measurement. The extraction of current information by magnetic connection eliminates common mode voltage considerations. Additionally, the clip-on convenience makes the probes as easy to use as a standard voltage mode probe. As good as they are, current probes have limitations and characteristics which must be remembered to avoid unpleasant surprises. At high currents, probe saturation limits may be encountered. Resultant CRT waveforms will be corrupted, rendering the measurement useless and confusing the unwary. For Hall types, measurement below a few hundred microamperes is limited by noise, which is much more obvious on the display. Keep in mind that current probes have different signal transit delay times than voltage probes or dissimilar current probes. At high sweep speeds this effect shows
up in multi-trace displays as time skewing between individual channels. The current probes transit time delay can be mentally factored in to reduce error when interpreting the display. Note that active probes have the longest signal transit times, on the order of 25 ns .
The AC probes low frequency bandwidth restriction must be kept in mind when interpreting CRT displays. Figure C2 clearly demonstrates this by showing the AC probes inability to follow low frequency. Similarly, remember that the probes stated bandpass is a -3 dB figure, meaning signal information is not entirely present in the display at this frequency. When working in regions approaching either end of the probe bandpass consider that displayed information may be distorted or incomplete.
There are other ways, albeit less convenient and desirable than clip-on current probes, to measure wideband current signals. Ohm explains that measuring voltage across a resistor gives current. Current shunts (Figure C3 foreground)


Figure C2. Hall Stabilized (Trace A) and Transformer (Trace B) Based Current Probes Responding to Low Frequency


Figure C3. Typical Current Shunts and an "isolated" Probe

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are low value (for LT1074 circuits 0.12 to 0.012 is typical) resistors with four terminal connections for accurate measurement. In theory, measuring voltage across a current shunt should yield accurate information. In practice, common mode voltages introduce measurement difficulties, particularly at speed. Making this measurement requires an isolated probe or a high speed differential plug-in. The Signal Acquisition Technologies SL-10 (Figure C3) has 10 MHz bandwidth, a galvanically floating input and 600 V common mode capability. This probe allows any oscilloscope to take a floating measurement across a shunt.

Differential oscilloscope plug-in's, while not galvanically floating, can measure across a shunt. Tektronix types W, 1 A 5 and 7A13 have 1 mV sensitivity with up to 100 MHz bandwidth and excellent common mode rejection. Types $1 A 7$ and $7 A 22$ have $10 \mu V$ sensitivity, although bandwidth is limited to 1 MHz . All differential plug-in's have bandwidth and/or common mode voltage restrictions that vary with sensitivity. These trade-offs must be reviewed when selecting the optimal shunt value for a particular measurement. In general the smallest practical shunt value is desirable. This minimizes the inserted resistances parasitic effects on circuit operation.

## APPENDIXD

## Optimizing Switching Regulators for Efficiency

Squeezing the utmost efficiency out of a switching regulator is a complex, demanding design task. Efficiency exceeding $80 \%-85 \%$ requires some combination of finesse, witchcraft and just plain luck. Interaction of electrical and magnetic terms produces subtle effects which influence efficiency. A detailed, generalized method for obtaining maximum converter efficiency is not readily described but some guidelines are possible.

Losses fall into several loose categories including junction, ohmic, drive, switching, and magnetic losses.
Semiconductor junctions produce losses. Diode drops increase with operating current and can be quite costly in low voltage output converters. A 700 mV drop in a 5 V output converter introduces more than $10 \%$ loss. Schottky devices will cut this nearly in half, but loss is still appreciable. Germanium (rarely used) is lower still, but switching losses negate the low DC drop at high speeds. In very low power converters Germanium's reverse leakage may be equally oppressive. Synchronously switched rectification is more complex, but can sometimes simulate a more efficient diode (see LTC Application Note 29, Figure 32). The LT1074's "Com Out"pin is intended to drive external synchronous switches. See Appendix A for details.

When evaluating synchronous rectification schemes remember to include both $A C$ and $D C$ drive losses in efficiency estimates. DC losses include base or gate current
in addition to $D C$ consumption in any driver stage. $A C$ losses might include the effects of gate (or base) capacitance, transition region dissipation (the switch spends some time in its linear region) and power lost due to timing skew between drive and actual switch action.

The LT1074's output switch is composed of a PNP driving a power NPN (Figure D1). The switch drop can reach 2V at high currents. This will usually be the major loss in the circuit. Its effect on efficiency can be mitigated by using the highest possible input voltage. Text Figure 7 shows 5V regulator efficiency improving almost $10 \%$ for higher input voltages. Higher output voltages will further minimize the switch losses.


Figure D1. Simplified LT1074 Output Switch
Actual losses caused by switch saturation effects and diode drops are sometimes difficult to ascertain. Changing duty cycles and time variant currents make determination tricky. One simple way to make relative loss

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judgements is to measure device temperature rise. Appropriate tools here include thermal probes and (at low voltages) the perhaps more readily available human finger. At lower power (e.g. less dissipation, even though loss percentage may be as great) this technique is less effective. Sometimes deliberately adding a known loss to the component in question and noting efficiency change allows loss determination.
Ohmic losses in conductors are usually only significant at higher currents. "Hidden" ohmic losses include socket and connector contact resistance and equivalent series resistance (ESR) in capacitors. ESR generally drops with capacitor value and rises with operating frequency, and should be specified on the capacitor datasheet. Consider the copper resistance of inductive components. It is often necessary to evaluate trade-offs of an inductors copper resistance vs. magnetic characteristics.
Switching losses occur when the LT1074 spends significant amounts of time in its linear region relative to operating frequency. At higher switching frequencies transition times can become a substantial loss source. The LT1074's 100 kHz pre-set switching frequency is a good compromise (for this device) and changes should be carefully considered. Raising the switching frequency to gain some desired benefit necessitates consideration of increased LT1074 losses. 200kHz is the maximum practical operating frequency.

Magnetics design also influences efficiency. Design of inductive components is well beyond the scope of this appended section, but issues include core material selection, wire type, winding techniques, size, operating frequency, current levels, temperature and other issues. Some of these topics are discussed in LTC Application Note 19, but there is no substitute for access to a skilled magnetics specialist. Fortunately, the other categories mentioned usually dominate losses, allowing good efficiencies to be obtained with standard magnetics. Custom magnetics are usually only employed after circuit losses have been reduced to lowest practical levels.

## A Special Circuit

In cases where input voltage must be low, but may float, Figure D2's circuit may be preferable to an LT1074 based approach. This circuit uses the LT1070, a common emitter output device. With the emitter connected to the ground pin this devices (LT1070 operating details are available in its datasheet, and in LTC Application Notes 19, 25 and 29) switch loss is significantly lower than the LT1074's. Although intended for voltage step-up in flyback configurations the LT1070 can be arranged to perform the step-down function. The advantage is the efficiency gain due to the reduced switch loss. The circuits primary restriction is that the input must float with respect to the output. Q1 performs a level shift to get the feedback information


MBR745 = MOTOROLA
L1 =PULSE ENGINEERING, INC. \#PE-92113
Figure D2. Floating Input Buck Regulator

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referenced to the LT1070 "ground" pin, which floats with the input. The LT1070 is effectively "fooled" and behaves like a flyback regulator. It is oblivious to the fact that the overall function is step-down, because the floating input is driven to the output potential. The negative side of the out-
put filter capacitor is connected to the ground ( $\stackrel{\perp}{\boldsymbol{L}}$ ) of the powered system, and the LT1070 input rail becomes the 5 V output. Other voltages are obtainable by altering the $3.9 \mathrm{k}-1.1 \mathrm{k}$ feedback ratio. Efficiency approaches $85 \%$.

## APPENDIXE

## A Half-Sine Reference Generator

Text Figure 31 's half-sine reference must be amplitude and frequency stabilized to a fairly high degree. It is not unreasonable to expect a $115 \mathrm{~V}_{\mathrm{AC}} 400 \mathrm{~Hz}$ source to be within 1 V and 0.1 Hz . Additionally, Figure 31's reference requires a half-sine, as opposed to the more normal full-sine. These requirements are achievable by classical analog techniques, but a digital approach eases complexity with no performance trade-off ${ }^{14}$. Figure E3 shows such an approach. C1 forms a 1.024 MHz crystal oscillator which is divided down by the 7490. The 7490's differentiated $\div 10$ output becomes the LT1074's 102.4 kHz sync. option output. The 7490 's $\div 5$ output ( 204.8 kHz ) is fed to the 74191 counters. These counters parallel load a 2716 EPROM which is programmed to produce an 8 -bit ( 256 states) digitally coded half-sine. The program, developed by Sean Gold and Guy M. Hoover, appears in Figure E1. The 2716's
parallel output is fed to an 8 -bit DAC, which produces 800 Hz 2.5 V (peak) half-sines.

Those wishing to utilize this reference for full-sines will find the appropriate software in Figure E2.
Figure E3 also shows the synchronous switch option discussed in the text. The 74C122 monostable forms a simple delayed pulse generator which drives the Q4 switch. The $20 \mu \mathrm{~S}$ delay and $6 \mu$ s pulse width set at the 74 C 122 were empirically determined to produce lowest overall crossover distortion in Figure 31's output.

Note 14: The sinewave is probably the paramount expression of the analog world. The Old Man Himself, George A. Philbrick, once elegantly discussed analog functions as "those which are continuous in excursion and time." He might have viewed digital production of a sinewave with considerable suspicion, or simply labeled it blasphemous. Such are the wages of progress.

Line tasel Colum Urap APL2/PG




 O5 DG DS DA DB DO DE EQ EI EJ EA EG ET EB EA EB
 FA FQ FQ FC FC FD FD FE FE FE FE FF FF FF FF FF
FF FF FF FF FF FE FE FE FE FD FD FC FC FB FB FA FA FS F8 F8 F7 F5 FS F4 F3 F3 F2 F1 EF EE ED EC

 $B 3$ B0 AE AC AS A7 AS A2 A8 90

 | $5 F$ | $5 C$ | 59 | 56 | 53 | 50 | 40 | $4 A$ | 47 | 44 | 41 | $3 E$ | 38 | 38 |
| :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- |



Figure E1. Hall-Sine Software Code for the 2716 EPROM
line la736 Column UPad APL2/PC
FF FF FF FF FE FE FE FD FD FC FB FA FS FG F7 F6 F5 F4 F3 FI Fe EE ED EB E9 E8 E6 EA E2 E8 OE DC D9 D7 DS D2 DO CE C8 C9 C6 C3 CI BE B8 88 $85 \quad 83$






 $\begin{array}{lllllllllllllllll}27 & 29 & 28 & 2 E & 30 & 33 & 35 & 38 & 3 A & 30 & 40 & 42 & 45 & 48 & 48 & 4 \mathrm{E} \\ 51 & 54 & 57 & 5 A & 50 & 60 & 63 & 66 & 59 & 6 C & 5 F & 72 & 75 & 78 & 7 C & 7 F\end{array}$




Figure E2. Full-Sine Software Code for the 2716 EPROM (Bonus)


Figure E3. Timing and Reference Half-Sine Generator for Figure 31

## Application Note 35

## APPENDIX F

## The Magnetics Issue

Magnetics is probably the most formidable issue in converter design. Design and construction of suitable magnetics is a difficult task, particularly for the non-specialist. It is our experience that the majority of converter design problems are associated with magnetics requirements. This consideration is accented by the fact that most converters are employed by non-specialists. As a purveyor of switching power IC's we incur responsibility towards addressing the magnetics issue (our publicly spirited attitude is, admittedly, capitalistically polluted). As such, it is LTC's policy to use off-the-shelf magnetics in our circuits. In some cases, available magnetics serve a particular design. In other situations the magnetics have been specially designed, assigned a part number and made available as standard product.

In many circumstances a standard product is suitable for production. Other cases may require modifications or changes which the manufacturer can provide or advise on. Hopefully, this approach serves the needs of all concerned.

Recommended magnetics manufacturers include the following;

Pulse Engineering, Inc.
P.O. Box 12235

7250 Convoy Court
San Diego, California 92112 619-268-2400

Coiltronics
984 Southwest 13th Court Pompano Beach, FL 33069
305-781-8900

AN35-30



[^0]:    Note 3: Methods for selecting appropriate inductors are discussed in Appendix B.

[^1]:    Note 8: For an example of this technique see LTC Application Note 29, Figure 1.

[^2]:    Note 12: Available from Pulse Engineering, Inc., P.O. Box 12235, San Diego, California 92112, 619-268-2400.

